	L#	Hits	Search Text	DBs
1	L1	5563	(257/723,737,738,778,779).ccl s.	US- PGPUB ; USPAT
2	L2	2741	(361/760,767-771,783).ccis.	US- PGPUB ; USPAT
3	L3	1791	174/260.ccls.	US- PGPUB ; USPAT
4	L4	1483	29/840.ccls.	US- PGPUB ; USPAT
5	L5	1230	438/108.ccls.	US- PGPUB ; USPAT
6	L6	987	228/180.22.ccls.	US- PGPUB ; USPAT
7	L7	11646	1 2 3 4 5 6	US- PGPUB ; USPAT
8	L8	1530	7 and @pd>="20040517"	US- PGPUB ; USPAT

	L#	Hits	Search Text	DBs
9	L9	454	8 and ((thermal with (expansion coefficient\$1)) cte tce tec)	US- PGPUB ; USPAT
10	L10	138	9 and mismatch\$3	US- PGPUB ; USPAT
11	L11	7	10 and elongation	US- PGPUB ; USPAT
12	L12	131	10 not 11	US- PGPUB ; USPAT
13	L13	15	12 and (elongate\$1 elongating)	US- PGPUB ; USPAT
14	L14	116	12 not 13	US- PGPUB ; USPAT
15	L15	316	9 not 10	US- PGPUB ; USPAT
16	L16	102314	((thermal with (expansion coefficient\$1)) cte tce tec)	EPO; JPO; DERWE NT; IBM_TD B

	L#	Hits	Search Text	DBs
17	L17	704	16 and mismatch\$3	EPO; JPO; DERWE NT; IBM_TE
18	L18	15	17 and elongat\$4	EPO; JPO; DERWE NT; IBM_TD
19	L19	689	17 not 18	EPO; JPO; DERWE NT; IBM_TD
20	L20	54	19 and (solder\$3 with (bump\$1 ball\$1))	EPO; JPO; DERWE NT; IBM_TD B
21	L21	635	19 not 20	EPO; JPO; DERWE NT; IBM_TD B

	L#	Hits	Search Text	DBs
22	L22	21	21 and (solder\$3 with joint\$1)	EPO; JPO; DERWE NT; IBM_TD B
23	L23	614	21 not 22	EPO; JPO; DERWE NT; IBM_TD B
24	L24	82	23 and expand\$3	EPO; JPO; DERWE NT; IBM_TD B
25	L25	532	23 not 24	EPO; JPO; DERWE NT; IBM_TD B
26	L26	1545	7 and expand\$3	US- PGPUB ; USPAT
27	L27	1450	26 not 9	US- PGPUB ; USPAT

	L#	Hits	Search Text	DBs
28	L28	0	27 and (solder\$3 with (bump\$1 ball\$1 joint\$1))	EPO; JPO; DERWE NT; IBM_TD B
29	L29	1240	27 and solder\$3	US- PGPUB ; USPAT
30	L30	1054	29 and (bump\$1 ball\$1 joint\$1)	US- PGPUB ; USPAT
31	L31	962	27 and (solder\$3 with (bump\$1 ball\$1 joint\$1))	US- PGPUB ; USPAT
32	L32	640	31 and stress\$2	US- PGPUB ; USPAT
33	L33	322	31 not 32	US- PGPUB ; USPAT